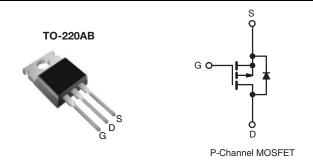


COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 6	- 60			
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = - 10 V	0.28			
Q _g (Max.) (nC)	19	19			
Q _{gs} (nC)	5.4	5.4			
Q _{gd} (nC)	11	11			
Configuration	Sing	Single			



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF9Z24PbF
Leau (FD)-liee	SiHF9Z24-E3
SnPb	IRF9Z24
SIFD	SiHF9Z24

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V_{DS}	- 60	V	
Gate-Source Voltage	V_{GS}	± 20	1 v	
Continuous Drain Current	V_{GS} at - 10 V $\frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$		- 11	А
	V_{GS} at - 10 V $T_C = 100 ^{\circ}C$	I _D	- 7.7	
Pulsed Drain Current ^a	I _{DM}	- 44		
Linear Derating Factor		0.40	W/°C	
Single Pulse Avalanche Energy ^b	E _{AS}	240	mJ	
Repetitive Avalanche Currenta	I _{AR}	- 11	Α	
Repetitive Avalanche Energy ^a	E _{AR}	6.0	mJ	
Maximum Power Dissipation	T _C = 25 °C	P_{D}	60	W
Peak Diode Recovery dV/dtc	dV/dt	- 4.5	V/ns	
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	ure) for 10 s			
Mounting Torque	6 22 or M2 ocross		10	lbf ⋅ in
	6-32 or M3 screw		1.1	N · m

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = -25 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 2.3 \,\text{mH}$, $R_{\alpha} = 25 \,\Omega$, $I_{AS} = -11 \,\text{A}$ (see fig. 12).
- c. $I_{SD} \le -11$ A, $dI/dt \le 140$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		,
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = - 1 mA		- 0.056	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-	- 4.0	V
Gate-Source Leakage	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Zon Oak William B. 1. C.		V _{DS} = - 60 V, V _{GS} = 0 V		-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 48 V,	V _{GS} = 0 V, T _J = 150 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 6.6 A ^b	-	-	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} = - 25 V, I _D = - 6.6 A ^b		1.4	-	-	S
Dynamic							•
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	570	-	pF
Output Capacitance	C _{oss}			-	360	-	
Reverse Transfer Capacitance	C _{rss}			-	65	-	
Total Gate Charge	Qg			-	-	19	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	I _D = - 11 A, V _{DS} = - 48 V, see fig. 6 and 13 ^b	-	-	5.4	nC
Gate-Drain Charge	Q _{gd}		see lig. o allo 13-	1	-	11	
Turn-On Delay Time	t _{d(on)}			-	13	-	
Rise Time	t _r	V_{DD} = - 30 V, I_{D} = - 11 A, R_{g} = 18 Ω, R_{D} = 2.5 Ω, see fig. 10 ^b		-	68	-	ns
Turn-Off Delay Time	t _{d(off)}			-	15	-	
Fall Time	t _f			-	29	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal Source Inductance	L _S			-	7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		ı	-	- 11	- A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 44	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = -11 A, V _{GS} = 0 V ^b		i	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = -11 A, dl/dt = 100 A/μs ^b		-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.32	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic turi	-on is do	minated b	v I e and	15)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

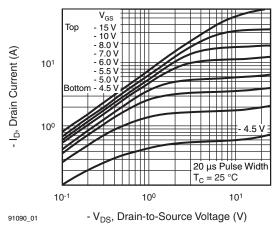


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

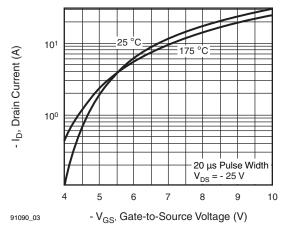


Fig. 3 - Typical Transfer Characteristics

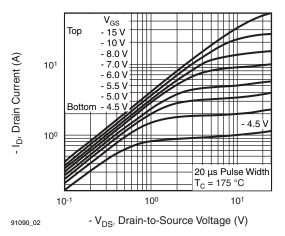


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

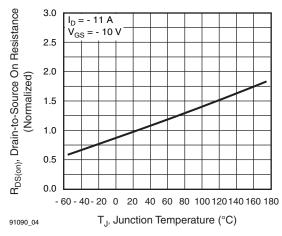


Fig. 4 - Normalized On-Resistance vs. Temperature



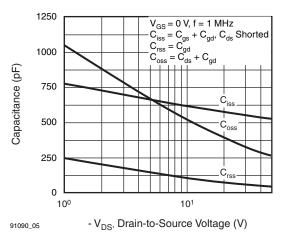


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

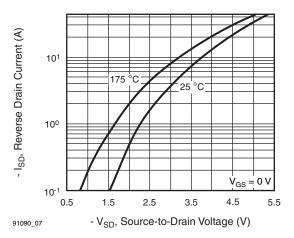


Fig. 7 - Typical Source-Drain Diode Forward Voltage

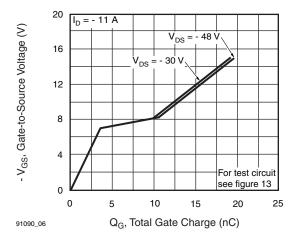


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

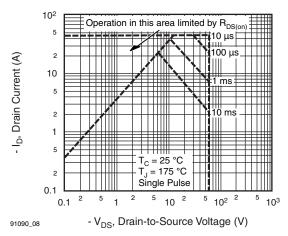


Fig. 8 - Maximum Safe Operating Area



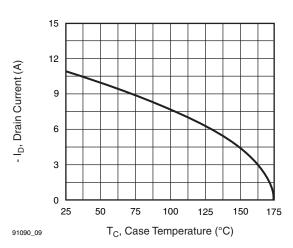


Fig. 9 - Maximum Drain Current vs. Case Temperature

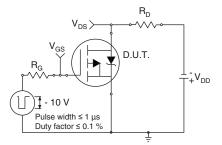


Fig. 10a - Switching Time Test Circuit

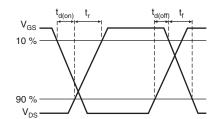


Fig. 10b - Switching Time Waveforms

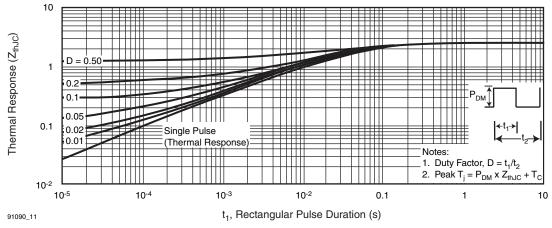


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



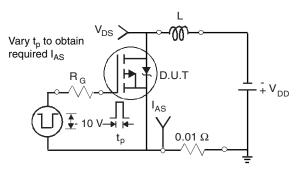


Fig. 12a - Unclamped Inductive Test Circuit

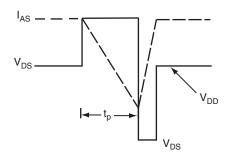


Fig. 12b - Unclamped Inductive Waveforms

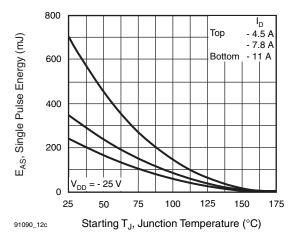


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

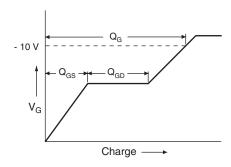


Fig. 13a - Basic Gate Charge Waveform

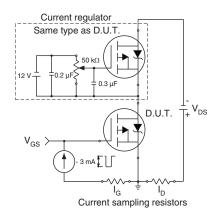
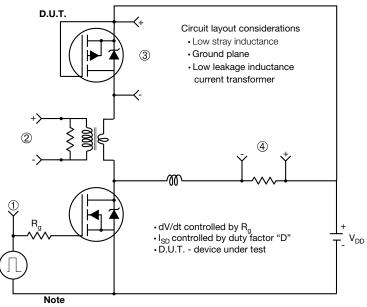


Fig. 13b - Gate Charge Test Circuit





Peak Diode Recovery dV/dt Test Circuit



· Compliment N-Channel of D.U.T. for driver

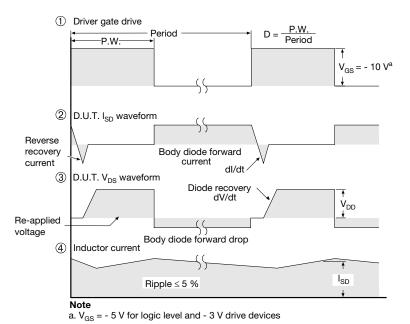


Fig. 14 - For P-Channel

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